

OMB No. 0651-0011

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INFORMATION DISCLOSURE STATEMENT	Atty. Docket No.: 59098US002	Serial No.: 10/729,114
	Applicant(s): BURTON et al.	Confirmation No.: 3162
	Application Filing Date: December 5, 2003	Group: 1611
	Information Disclosure Statement mailed: September <u>9</u> , 2008	

U.S. PATENT DOCUMENTS

Examiner Initial	Copy Enclosed	Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate
		4,768,503	09-06-1988	Highgate et al.			
		5,803,086	09-08-1998	Scholz et al.			
		5,897,694	04-27-1999	Woolf			
		US 2006/0251893	11-09-2006	Boulos et al.			

U.S. PATENT APPLICATIONS BY SERIAL NUMBER

Examiner Initial	Copy Enclosed	Document Number	Filing Date	Name	Class	Subclass
		None				

FOREIGN PATENT DOCUMENTS

Examiner Initial	Copy Enclosed	Document Number	Date	Country	Class	Subclass	Translation	
							Yes	No
		None						

OTHER DOCUMENTS (Including Authors, Title, Date, Pertinent Papers, etc.)

Examiner Initial	Copy Enclosed	Document Description
	X	"Adhesives," <i>British Pharmacopoeia</i> , Appendix XX H, 1988, H.M.S.O. London: A222-A223 (Exhibit B).
	X	Madavi et al., "Preparation and evaluation of cosmetic patches containing lactic and glycolic acids," <i>Indian Journal of Dermatology, Venerology and Leprology</i> , Nov-Dec. 2006;72(6):432-436 (Exhibit C).
	X	"Sheetable Polyester Label Material" datasheet [online]. 3M, St. Paul, MN, January 1, 1999. [retrieved on September 4, 2008]. Retrieved from the Internet: <URL: http://www.safetylevel.com/pdfs/3m7908.pdf >; 4 pgs (Exhibit A).
	X	Wokovich et al., "Evaluation of substrates for 90 degree peel adhesion- A collaborative study. I. Medical Tapes," <i>J. Biomed Mater Research Part B: Appl Biomater</i> , Published online April 3, 2008. Retrieved from the internet of 6 August 2008 from http://www.3.interscience.wiley.com/cgi-bin/fulltext/119818079/main.html,ftx_abs (6 pgs.) (Exhibit D).

EXAMINER	Date Considered
<p>*Examiner: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.</p>	